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R8C/L3AC Group

LCD Drive Control Circuit (External Division Resistor, Blink Function)

1. Abstract

This document describes the setting method and an application example of the LCD drive control circuit (when using external division resistor, blink function) for the R8C/L3AC Group.

2. Introduction

The application example described in this document applies to the following MCU:

• MCU: R8C/L3AC Group

The sample program in this application note can be used with other R8C Family MCUs which have the same special function registers (SFRs) as the above group. Check the manual for any modifications to functions. Careful evaluation is recommended before using the sample program described in this application note.



3. Application Example

3.1 LCD Display

Outline: Use the LCD drive control circuit to display the LCD.

Specifications:

- Use segment pins SEG0 to SEG23 and common pins COM0 to COM3.
- Duty = 1/4, bias value = 1/3
- Frame frequency = 76 Hz

$$f(FR) = \frac{f(LCDCK) \times duty}{2}$$

$$f(LCDCK) = LCD clock source frequency$$

Notes: n = 32 when f32 is selected n = 4 when fC-LCD is selected

LCD clock source frequency = f32 = (high-speed on-chip oscillator divided by 2) / 32

n = 32

f(LCDCK) =

Division ratio = divide by 32

• Use the external division resistors.

- Data display control interval = $f(FR) \times 32$ counts = 0.42 seconds
- Enable LCD display control and display LCD blink.

n x division ratio

• Display as R8C/LX.

Figure 3.1 shows a Segment Layout. Figure 3.2 shows a Circuit Example When Using External Division Resistor. Figure 3.3 shows the LCD Display Data Register Settings.

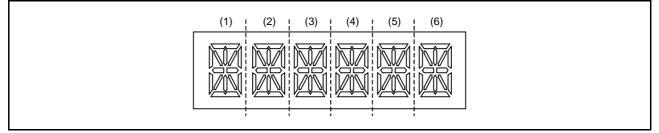


Figure 3.1 Segment Layout



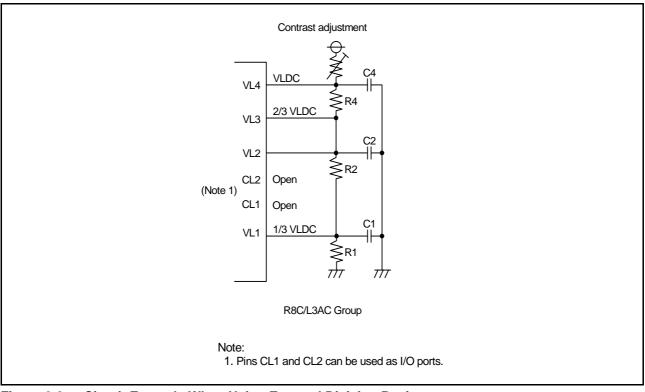
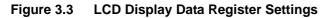


Figure 3.2 Circuit Example When Using External Division Resistor

	Bit	7	6	5	4	3	2	1	0		
Address		COM7	COM6	COM5	COM4	COM3	COM2	COM1	COM0	Digit	
0210h	LRA0L					d	С	b	а	→ (1)	<u>N&</u> □/I
0211h	LRA1L					h	g	f	е	→ (1)	
0212h	LRA2L					k	j		i	→ (1)	
0213h	LRA3L					n	m			→ (1)	
0214h	LRA4L					d	С	b	а	→(2)	
0215h	LRA5L					h	g	f	е	→(2)	1) ////\ (
0216h	LRA6L					k	j		i	→(2)	g /1/ m 📉 d
0217h	LRA7L					n	m			→(2)	
0218h	LRA8L					d	С	b	а	→(3)	
0219h	LRA9L					h	g	f	е	→(3)	
021Ah	LRA10L	The	ese bits a	are not us	sed	k n	j		i	→(3)	
021Bh	LRA11L		in this application note				m			→ (3)	
021Ch	LRA12L		can be u			d	С	b	а	→(4)	
021Dh	LRA13L	(incy	can be u	300 03 1		h	g	f	е	→(4)	
021Eh	LRA14L					k	j		i	→(4)	
021Fh	LRA15L					n	m			→(4)	
0220h	LRA16L					d	С	b	а	→(5)	
0221h	LRA17L					h	g	f	е	→(5)	
0222h	LRA18L					k	j		i	→(5)	
0223h	LRA19L					n	m			→(5)	
0224h	LRA20L					d	С	b	а	→(6)	
0225h	LRA21L					h	g	f	е	→(6)	
0226h	LRA22L					k	j		i	→(6)	
0227h	LRA23L					n	m			→(6)	





3.2 Memory

Table 3.1 Memory

Memory	Size	Remarks				
ROM	271 bytes	In the rej05b1164_src.c module				
RAM	0 bytes	In the rej05b1164_src.c module				
Maximum user stack	10 bytes					
Maximum interrupt stack	0 bytes					

Memory size varies depending on the C compiler version and compile options.

The above applies to the following conditions:

• C compiler: M16C/60, 30, 20, 10, and Tiny, and R8C/Tiny Series Compiler V.5.45 Release 00

• Compile option: -c -finfo -dir "\$(CONFIGDIR)" -R8CE



4. Software Outline

This section shows the setting procedures and values to set the example described in section 3. Application Example. Refer to the latest R8C/L3AC Group Hardware Manual for details on individual registers.

The \times in the register's Setting Value represents bits not used in this application, blank spaces represent bits that do not change, and the hyphen represents reserved bits or bits that have nothing assigned.

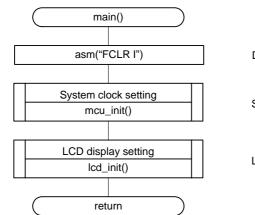
4.1 Function Tables

Declaration	void mcu_init(void)	void mcu_init(void)						
Outline	System clock settin	g						
Argumont	Argument name		Meaning					
Argument	None		—					
Variable (global)	Variable name		Contents					
Valiable (global)	None		— Contents — Meaning —					
Returned value	Туре	Value	Meaning					
Returned value	None	—	—					
Function	Set the system cloc	k (high-speed on-chip o	oscillator).					

Declaration	void lcd_init(void)		
Outline	LCD display setting		
Argument	Argument name		Meaning
Argument	None		Meaning — Contents —
Variable (global)	Variable name		Contents
Valiable (global)	None		—
Returned value	Туре	Value	Meaning
Returned value	None	—	—
Function	Set registers associ	ated with the LCD.	



- 4.2 Main Function
 - Flowchart



Disable interrupts.

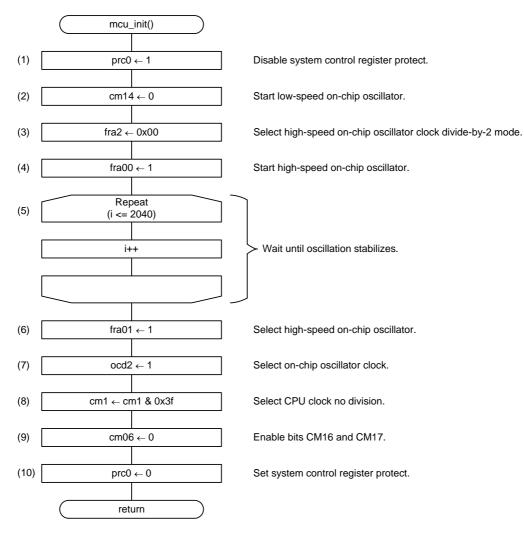
System clock set (high-speed on-chip oscillator set)

LCD display set



4.3 System Clock Setting

Flowchart





Register Settings

(1) Enable writing to registers CM0, CM1, CM3, OCD, FRA0, FRA1, FRA2, and FRA3.

Prote	ect Regis	ter (Pl	RCR)										
	Bit	b7	b6	b5	b4	b3	b2	b1	b0				
Setting V	Value					×		×	1				
Bit	Symbol		Bit Nar	ne		Function							
b0	PRC0	Protec	ct bit 0		FRA1, F	Enables writing to registers CM0, CM1, CM3, OCD, FRA0, FRA1, FRA2, and FRA3. 1: Write enabled							

(2) Oscillate the low-speed on-chip oscillator.

Bit	b7	b6	b5	b4	b3	b2	b1	b0	
Setting value			_	0	×	×	×	×	
-									

Bit	Symbol	Bit Name	Function	R/W
b4	CM14	Low-speed on-chip oscillator oscillation stop bit	0: Low-speed on-chip oscillator on	R/W

(3) Set the division ratio for the high-speed on-chip oscillator.

High-Speed On-Chip Oscillator Control Register 2 (FRA2)

Bit	b7	b6	b5	b4	b3	b2	b1	b0
Setting value		—	—			0	0	0

Bit	Symbol	Bit Name	Function	R/W
b0		High-speed on-chip oscillator	Division ratio selection	R/W
b1	FRA21	frequency switch bit	These bits select the division ratio for the high-speed	R/W
b2	FRA22		on-chip oscillator clock.	R/W
			b2 b1 b0	
			0 0 0: Divide-by-2 mode	

(4) Oscillate the high-speed on-chip oscillator.

High-Speed On-Chip Oscillator Control Register 0 (FRA0)

	Bit	b7	b6	b5	b4		b3	b2	b1	b0		
Setting	value	—	—	—	_		×	_		1		
Bit Symbol Bit Name					Function						R/W	
b0	FRA00	High-sp	High-speed on-chip oscillator				1: High-speed on-chip oscillator on					
		enable										

(5) Wait until oscillation stabilizes.



(6) Select the high-speed on-chip oscillator.

High-Speed On-Chip Oscillator Control Register 0 (FRA0)											
	Bit	b7	b6	b5	b4	b3	b2	b1	b0		
Setting	value					×		1			
Bit	Symbol		Bit N	ame				R/W			
b1	FRA01	High-spe	eed on-chi	p oscillato	select	1: High-spee		R/W			
		bit									

(7) Select the on-chip oscillator clock as the system clock.

Oscillation Stop Detection Register (OCD)													
Bit b7 b6 b5 b4 b3 b2 b1 b0													
Setting	value	-		—	—	—	×	1	×	×			
	_												
Bit Symbol Bit Name						Function							
b2	OCD)2	2 On-chip oscillator clock select bit					1: On-chip oscillator clock selected					

(8) Set CPU clock division select bit 1.

System Clock Control	Register 1 (CM1)
----------------------	------------------

Bit	b7	b6	b5	b4	b3	b2	b1	b0
Setting value	0	0	_		×	×	×	×

Bit	Symbol	Bit Name	Function	R/W
b6	CM16		^{b7 b6} 0 0: No division mode	R/W
b7	CM17			R/W

(9) Set CPU clock division select bit 0.

System Clock Control Register 0 (CM0)	

	Bit	b7	b6	b5	b4	b3	b2	b1	b0		
Setting	value	×	0	×	×	×	×	×	—		
			•								
Bit	Symbol		Bit N	ame				Function			R/W
b6	CM06	CPU clo	ock divisior	select bit	0	0: Bits CM10	6 and CM1	7 in CM1 re	egister enat	bled	R/W

R/W R/W



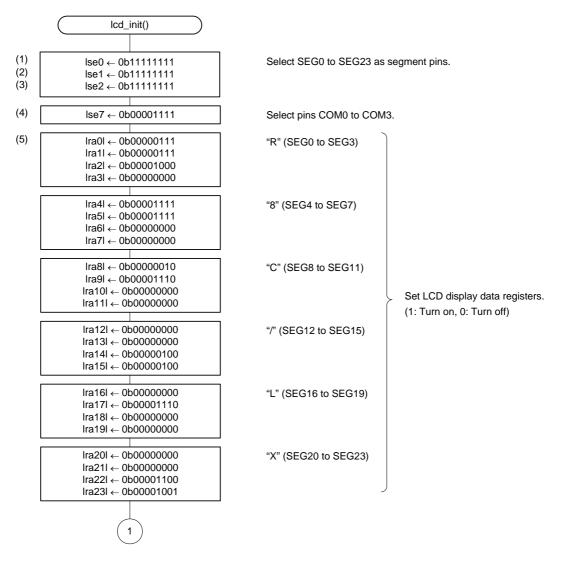
(10) Disable writing to registers CM0, CM1, CM3, OCD, FRA0, FRA1, FRA2, and FRA3.

Prote	ect Regi	ster (P	RCR)										
	Bit	b7	b6	b5	b4	b3	b2	b1	b0				
Setting	value		—	—	—	×	—	×	0]			
Bit	Symbol		Bit Nar	ne		Function							
b0	PRC0	Prote	ct bit 0			writing to r RA2, and F disabled		M0, CM1,	CM3, OCE), FRA0,	R/W		



4.4 LCD Display Setting

Flowchart





(6)	Ira0h ← 0b00000111 Ira1h ← 0b00000111 Ira2h ← 0b0001000 Ira3h ← 0b0000000	"R" (SEG0 to SEG3)
	Ira4h ← 0b00001111 Ira5h ← 0b00001111 Ira6h ← 0b0000000 Ira7h ← 0b0000000	"8" (SEG4 to SEG7)
	Ira8h ← 0b00000010 Ira9h ← 0b00001110 Ira10h ← 0b0000000 Ira11h ← 0b00000000	"C" (SEG8 to SEG11) Set LCD display control data registers. (1: Blink, 0: No blink)
	lra12h ← 0b0000000 lra13h ← 0b0000000 lra14h ← 0b0000100 lra15h ← 0b0000100	"/" (SEG12 to SEG15)
	Ira16h ← 0b0000000 Ira17h ← 0b00001110 Ira18h ← 0b0000000 Ira19h ← 0b00000000	"L" (SEG16 to SEG19)
	lra20h ← 0b00000000 lra21h ← 0b00000000 lra22h ← 0b00001100 lra23h ← 0b00001001	"X" (SEG20 to SEG23)
		Select divide-by-32 as division ratio.
(7)	lcr3 ← 0x05	Select f32 as LCD clock source.
(8)	lcr2 ← 0x09	Select f(FR) x 32 counts as LCD data display control interval. Select blink display. Enable LCD data display control.
(9)	lcr1 ← 0x00	Disable voltage multiplier.
(10)	lcr0 ← 0xd3	Select 1/4 duty (use pins COM3 to COM0) Select segment panel control waveform. Select 1/3 bias. Enable LCD display.
	return	Start LCD drive.



• Register Settings

(1) Set port P0 as a segment pin.

LCD	Port S	elect Re	egister 0 (LSE0)								
	Bit	b7	b6	b5	b4	b3	b2	b1	b0			
Setting value		1	1	1	1	1	1	1	1			
Bit	Symbo		Bit Na	ne			Fu	nction		R/W		
b0	LSE00		port select		1: SEG0					R/W		
b1	LSE01	LCD	port select	bit 1	1: SEG1					R/W		
b2	LSE02	2 LCD	port select	bit 2	1: SEG2					R/W		
b3	LSE03	3 LCD	port select	bit 3	1: SEG3	1: SEG3						
b4	LSE04	LCD	port select	bit 4	1: SEG4	1: SEG4						
b5	LSE05	5 LCD	port select	bit 5	1: SEG5	1: SEG5						
b6	LSE06	3 LCD	port select	bit 6	1: SEG6					R/W		
b7	LSE07	LCD	port select	bit 7	1: SEG7					R/W		

(2) Set port P1 as a segment pin.

LCD Port Select Register 1 (LSE1)

Bit	b7	b6	b5	b4	b3	b2	b1	b0	
Setting value	1	1	1	1	1	1	1	1	l

Bit	Symbol	Bit Name	Function	R/W
b0	LSE08	LCD port select bit 8	1: SEG8	R/W
b1	LSE09	LCD port select bit 9	1: SEG9	R/W
b2	LSE10	LCD port select bit 10	1: SEG10	R/W
b3	LSE11	LCD port select bit 11	1: SEG11	R/W
b4	LSE12	LCD port select bit 12	1: SEG12	R/W
b5	LSE13	LCD port select bit 13	1: SEG13	R/W
b6	LSE14	LCD port select bit 14	1: SEG14	R/W
b7	LSE15	LCD port select bit 15	1: SEG15	R/W

(3) Set port P2 as a segment pin.

LCD Port Select Register 2 (LSE2)

		Bit	b7	b6	b5	b4	b3	b2	b1	b0				
	Setting	value	1	1	1	1	1	1	1	1				
ſ	5.			51.11								R/W		
	Bit	Symb		Bit Na	me		Function							
	b0	LSE	16 LCD	port select	bit 16	1: SEG1	1: SEG16							
	b1	LSE	17 LCD	port select	bit 17	1: SEG1	7					R/W		
	b2	LSE	18 LCD	port select	bit 18	1: SEG1	8					R/W		
	L 0				1 1 40	4 0504	^					D // //		

b3	LSE19	LCD port select bit 19	1: SEG19	R/W
b4	LSE20	LCD port select bit 20	1: SEG20	R/W
b5	LSE21	LCD port select bit 21	1: SEG21	R/W
b6		LCD port select bit 22	1: SEG22	R/W
b7	LSE23	LCD port select bit 23	1: SEG23	R/W



(4) Set ports P7_4 to P7_7 as COM pins.

LCD	Port	Select	Register 7 (LSE7)							
	Bit	b7	b6	b5	b4	b3	b2	b1	b0		
Setting	value	_	—	—	0	1	1	1	1		
Bit	Sym	bol	Bit Na	ne			Fu	nction			R/W
b0	LSE		D port select	bit 56	1: COM	1: COM3					R/W
b1	LSE	57 LC	D port select	bit 57	1: COM	2					R/W
b2	LSE	58 LC	CD port select	bit 58	1: COM	1					R/W
b3	LSE	59 LC	CD port select	bit 59	1: COM	C					R/W
b4	LSE	60 LC	CD port select	bit 60	1: Ports	P12_2 and	P12_3				R/W

(5) Set the LCD display data register.

When 1 is written to a bit in the LCD display data register (LRAL), the corresponding segment of the LCD panel is turned on, when a bit is set to 0, the corresponding segment is turned off.

		bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
Symbol	Address	COM7	COM6	COM5	COM4	COM3	COM2	COM1	СОМ0
LRA0L	0210h				SE	G0			
LRA1L	0211h				SE	G1			
LRA2L	0212h				SE	G2			
LRA3L	0213h				SE	G3			
LRA4L	0214h				SE	G4			
LRA5L	0215h				SE	G5			
LRA6L	0216h				SE	G6			
LRA7L	0217h				SE	G7			
LRA8L	0218h				SE	G8			
LRA9L	0219h				SE	G9			
LRA10L	021Ah				SE	G10			
LRA11L	021Bh				SE	G11			
LRA12L	021Ch				SE	G12			
LRA13L	021Dh				SE	G13			
LRA14L	021Eh				SE	G14			
LRA15L	021Fh				SE	G15			
LRA16L	0220h				SE	G16			
LRA17L	0221h		SEG17						
LRA18L	0222h	SEG18							
LRA19L	0223h	SEG19							
LRA20L	0224h	SEG20							
LRA21L	0225h	SEG21							
LRA22L	0226h	SEG22							
LRA23L	0227h				SE	G23			



(6) Set the LCD display control data register.

When 1 is written to a bit in the LCD display control data register (LRAH), the corresponding segment of the LCD is blinked for the interval selected by bits LDFR0 to LDFR2.

Cumphel	A ddra a a	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
Symbol	Address	COM7	COM6	COM5	COM4	СОМЗ	COM2	COM1	COM0
LRA0H	0270h				SE	G0			
LRA1H	0271h				SE	G1			
LRA2H	0272h				SE	G2			
LRA3H	0273h				SE	G3			
LRA4H	0274h				SE	G4			
LRA5H	0275h				SE	G5			
LRA6H	0276h				SE	G6			
LRA7H	0277h				SE	G7			
LRA8H	0278h				SE	G8			
LRA9H	0279h				SE	G9			
LRA10H	027Ah				SEC	G10			
LRA11H	027Bh				SEC	G11			
LRA12H	027Ch				SEC	G12			
LRA13H	027Dh				SEC	G13			
LRA14H	027Eh				SEC	G14			
LRA15H	027Fh				SEC	G15			
LRA16H	0280h				SEC	G16			
LRA17H	0281h		SEG17						
LRA18H	0282h	SEG18							
LRA19H	0283h	SEG19							
LRA20H	0284h	SEG20							
LRA21H	0285h	SEG21							
LRA22H	0286h	SEG22							
LRA23H	0287h				SEC	G23			

(7) Set the division ratio and LCD clock source.

LCD Cloc	k Control	Register	(LCR3)					
Bit	b7	b6	b5	b4	b3	b2	b1	
Setting value	0	0				1	0	

Bit	Symbol	Bit Name	Function	R/W
b0	LPSC0	Division ratio select bit	^{b2 b1 b0} 1 0 1: Divide-by-32	R/W
b1	LPSC1		TO T. Divide-by-52	R/W
b2	LPSC2			R/W
b6	LCKS0		^{b7 b6} 0 0: f32	R/W
b7	LCKS1		0.152	R/W

b0 1



(8) Select the LCD data display control interval, enable the data display control, and select the display control mode.

LC	D Display	Contro	ol Register	(LCR2)							
	Bit	b7	b6	b5	b4	b3	b2	b1	b0		
Setting	g value	—	0	0	0	1	0	0	1		
Bit	Symbol	Bit	t Name				Functi	on			R/W
b0	LDFR0	LCD da	ata display								R/W
b1	LDFR1	control	interval						DTY2 to LDTY		R/W
b2	LDFR2	select l (counts) frequei	s the frame	^{b2 b1 b0} 0 0 1: D	isplay cont	rol interval	= f(FR)	(oth × 32 count	er than 1/3 duty S)	R/W
b3	LDSPC		ata display enable bit	1: Data d	display con	trol enable	d				R/W
b4	LRVRS	LCD di control select	mode	0: On/off	display						R/W
b5	LDFR20		ata display	b6 b5	ttings of hit) on oblod			R/W
b6	LDFR21	select (synch	interval bit 2 ronized ner RE)	00.Se	ttings of bit	S LDEKU (R/W

(9) Select the voltage multiplier wait time and voltage multiplier reference voltage source, and enable the voltage multiplier.

LCD Bias Control Register (LCR1)

Bit	b7	b6	b5	b4	b3	b2	b1	b0
Setting value	1	0	0	0	×	×	×	×

Bit	Symbol	Bit Name		Function	R/W
b4	LVWT0	Voltage multiplier wait			R/W
b5	LVWT1	time select bit	^{b5 b4} 0 0 : Wait time = f(FR)	Other than LDTY2 to LDTY0 = 010b (other than 1/3 duty) × 64 counts	R/W
b6	LVURS	Voltage multiplier reference voltage source select bit	0: VL1 externally-input vo	Itage	R/W
b7	LVUPE	Voltage multiplier enable bit	1: Voltage multiplier enab	led	R/W



(10) Select the duty, waveform control, and bias. Turn on the LCD display and start the LCD drive.

LCD	Contro	ol Regis	ter (LCR0))						
	Bit	b7	b6	b5	b4	b3	b2	b1	b0	
Setting	value	1	1	0	1	0	0	1	1	
Bit	Symbo	ol	Bit	Name				Function		R/W
b0	LDTY	0 Duty	select Bit			b2 b1 b0) upped)	R/W
b1	LDTY	1				0 1 1: 1/4 0			s usea)	R/W
b2	LDTY	2								R/W
b3	LWAV	/ LCD	waveform	control sel	ect bit	0: Segment	panel cor	trol wavef	orm	R/W
b4	LBAS	0 Bias	select bit			^{b5 b4} 0 1: 1/3 bia				R/W
b5	LBAS	1				0 1. 1/3 016	10			R/W
b6	LDSP	E LCD	display ena	able bit		1: LCD on				R/W
b7	LSTA	T LCD	drive start	bit		1: Drive sta	rts			R/W



5. Sample Program

A sample program can be downloaded from the Renesas Technology website. To download, click "Application Notes" in the left-hand side menu of the R8C Family page.

6. Reference Documents

Hardware Manual R8C/L3AC Group Hardware Manual Rev.0.10 The latest version can be downloaded from the Renesas Technology website.

Technical Update/Technical News The latest information can be downloaded from the Renesas Technology website.



Website and Support

Renesas Technology website http://www.renesas.com/

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	R8C/L3AC Group
REVISION HISTORY	LCD Drive Control Circuit (External Division Resistor, Blink
	Function)

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